

## Master Bond EP30M3LV Electrically Insulative, Low Viscosity Two Component Epoxy

Category: Polymer, Adhesive, Thermoset, Epoxy, Epoxy, Adhesive, Epoxy, Encapsulant, Unreinforced

## **Material Notes:**

Master Bond Polymer System EP30M3LV is a lower viscosity, two component epoxy system for high performance bonding, sealing and encapsulation. It is formulated to cure at ambient temperatures or more rapidly at elevated temperatures. It has a lower exotherm and a longer working life, which makes it highly desirable for moderate to larger encapsulations. It features superior electrical insulation properties.

## Order this product through the following link:

http://www.lookpolymers.com/polymer\_Master-Bond-EP30M3LV-Electrically-Insulative-Low-Viscosity-Two-Component-Epoxy.php

Physical Properties	Metric	English	Comments
Viscosity	2000 - 3000 cP	2000 - 3000 cP	
	@Temperature 23.0 °C	@Temperature 73.4 °F	

Thermal Properties	Metric	English	Comments	
Maximum Service Temperature, Air	121 °C	250 °F		
Minimum Service Temperature, Air	-51.1 °C	-60.0 °F		

Processing Properties	Metric	English	Comments
Cure Time	180 - 240 min	3.00 - 4.00 hour	
	@Temperature 93.3 °C	@Temperature 200 °F	
	2880 - 4320 min	48.0 - 72.0 hour	
	@Temperature 23.0 °C	@Temperature 73.4 °F	

Descriptive Properties	Value	Comments	
Color Code	"A" Black; "B" Brown		
Mix Ratio By Weight	100/50		
Set-Up Time, minutes	130-150	At Room Temperature	

## **Contact Songhan Plastic Technology Co.,Ltd.**

Website: www.lookpolymers.com Email: sales@lookpolymers.com

Tel: +86 021-51131842 Mobile: +86 13061808058



Skype: lookpolymers

Address: United North Road 215, Fengxian District, Shanghai City, China